

Audio Jack Detector and Pop Noise Control Switch

DESCRIPTION

The DG2591 is an audio jack detector and pop noise control switch IC. When there is no ear phone detected, the DG2591 connects the microphone bias line to ground through the MIC pin.

When there is no ear phone detected, the DG2591 connects the microphone bias line to ground through the MIC pin. The DG2591 also gives a logic HIGH signal to the baseband controller through the OUT pin.

The DG2591 senses the DC levels at both L_Detect and GND_Detect. When an ear phone is plugged in, the voltage at both pins will go low. The DG2591 will indicate the presence of the ear phone by pulling OUT low and the MIC switch will turn off.

The DG2591 is available ultra small miniQFN6 of 1 mm x 1.2 mm size.

FEATURES

- Operates with $1.8\text{ V} \pm 5\%$
- Low quiescent current of $2\text{ }\mu\text{A}/\text{max}$.
- Integrated sense comparator for audio L of $1.4\text{ V} \pm 5\%$ threshold
- $1\text{ }\Omega/\text{max}$. MIC bias switch provides a quick discharge and clamping
- (Integrated deglitch circuit)
- ESD Protected
 - Human body model $> 5\text{ kV}$
 - Charged device model $> 1\text{ kV}$
 - IEC 61000-4-2 air discharge $> 15\text{ kV}$
 - IEC 61000-4-2 contact discharge $> 8\text{ kV}$
- Ultra compact miniQFN6 of 1 mm x 1.2 mm
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



RoHS
COMPLIANT
HALOGEN
FREE

APPLICATIONS

- Cellular phones
- Tablet devices
- Portable media players
- Digital cameras

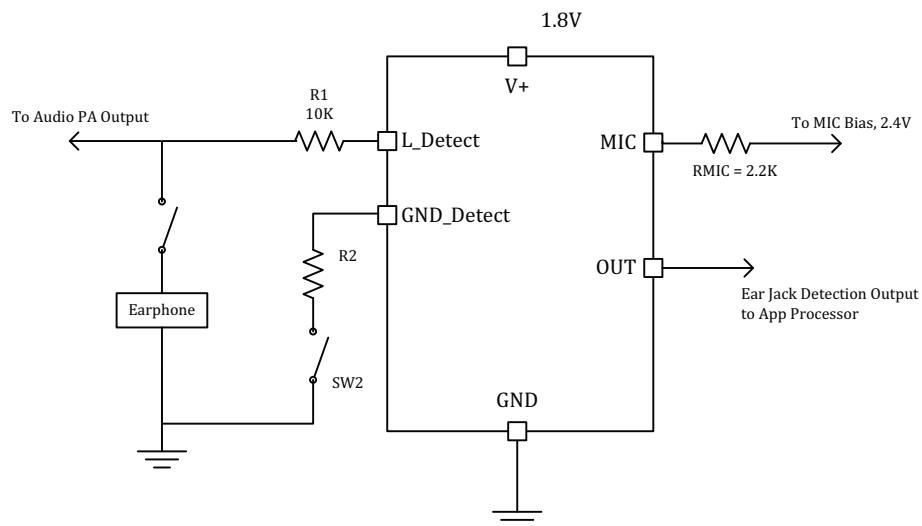


Fig. 1 - Typical Operation Circuit

PACKAGE OUTLINE

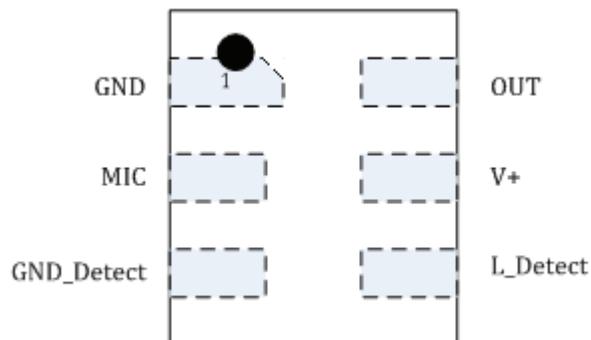
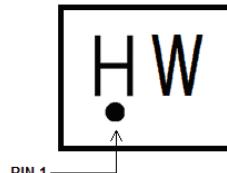


Fig. 2 - Device Pin Out miniQFN6 Top View, Pin 1 Dot Marking is on Top of the Device

PIN DESCRIPTION		
PIN#	NAME	FUNCTION
1	GND	Ground
2	MIC	Microphone bias switch input. Connect to AUXMIC_IN
3	GND_Detect	Connect to ground detect pin at audio jack
4	L_Detect	Connected to L_Detect pin at audio jack
5	V+	Device power supply connected to 1.8 V source
6	OUT	Detect logic output connected to baseband controller

ORDERING INFORMATION		
TEMPERATURE RANGE	PACKAGE	PART NUMBER
-40 °C to 85 °C	miniQFN6	DG2591DN-T1-GE4

DEVICE MARKING



H = DG2591 Marking Code, W = Date/Lot Traceability Code

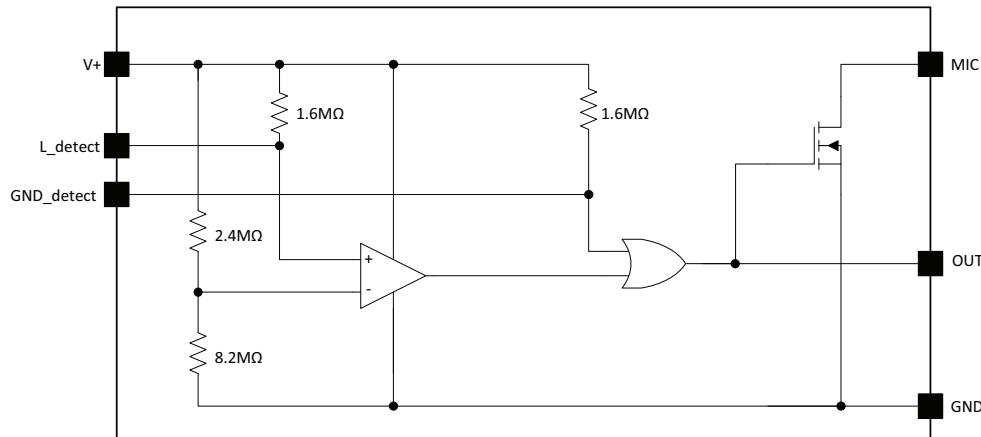


Fig. 3 - Functional Block Diagram

TRUTH TABLE			
L_DETECT	GND_DETECT	OUT	MIC
0	0	Low	High
1	x	High	Low
x	1	High	Low

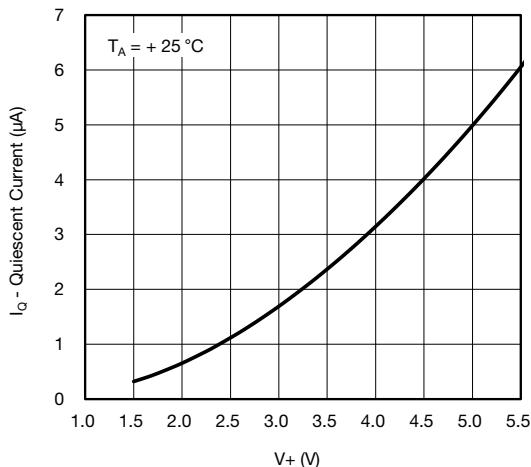
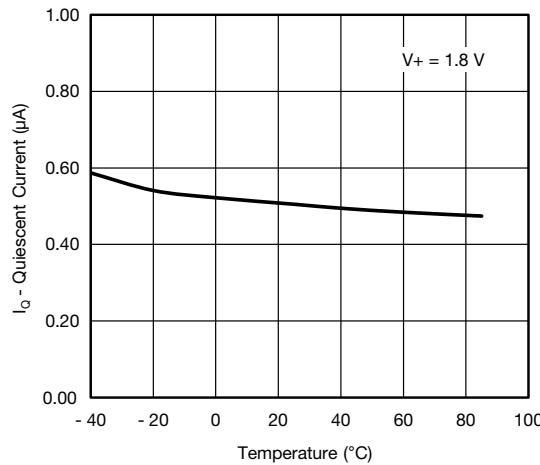
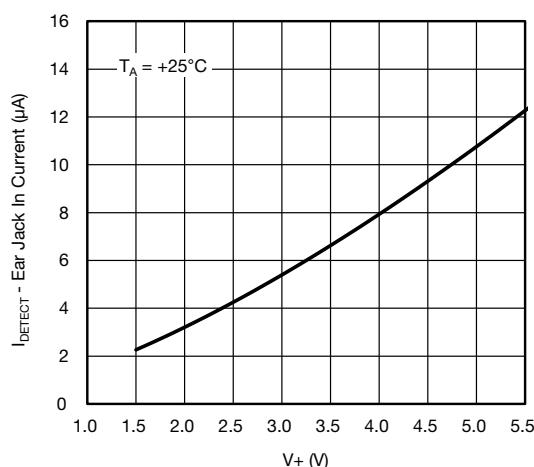
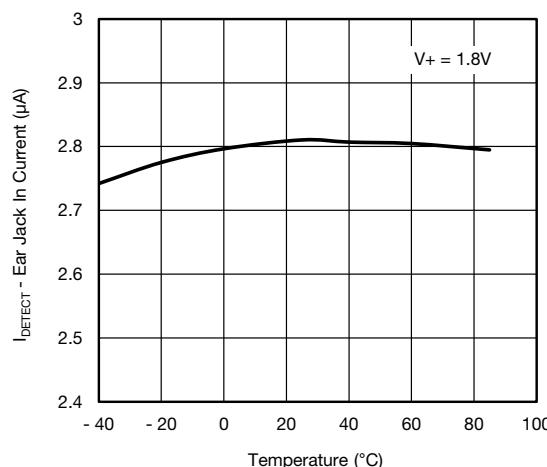
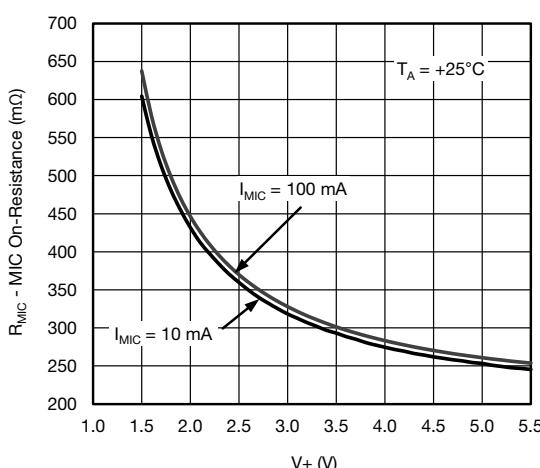
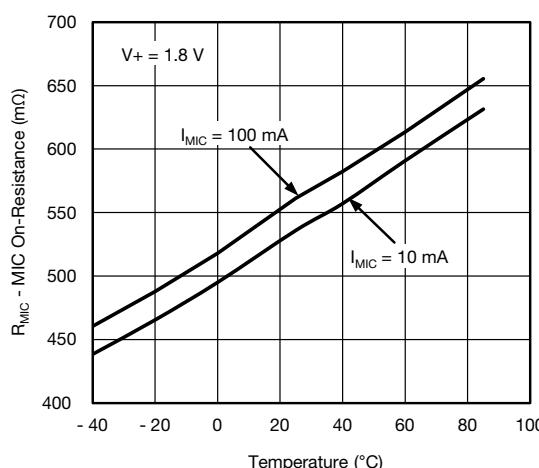
ABSOLUTE MAXIMUM RATINGS					
PINS OR PARAMETERS	CONDITIONS		LIMITS	UNIT	
V+	Reference to GND		-0.3 to 6	V	
L_Detect, GND_Detect, OUT	Reference to GND		V+		
MIC			-0.3 to 6		
Storage Temperature			-65 to +150	°C	
MSL	Moisture Sensitivity Level (JEDEC® J-STD-020)		1	Level	
I _{MIC}	Switch DC current		200	mA	
I _{MICPEAK}	Switch peak current (pulsed at 1 ms, < 10 % duty cycle)		500		
Latch up Current per JESD78			500		
ESD	Human body model		> 5	kV	
	IEC 61000-2-4, Level 4, L_Detect, GND_Detect, MIC and GND Pins	Contact	> 8		
		Air	> 15		
	Charged device model, JESD22-C101		> 1		
RECOMMENDED OPERATING CONDITION					
V+			1.8	V	
Operating Junction Temperature			-40 ~ +125	°C	

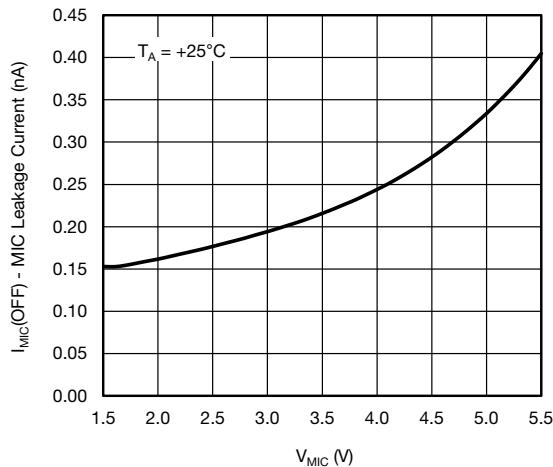
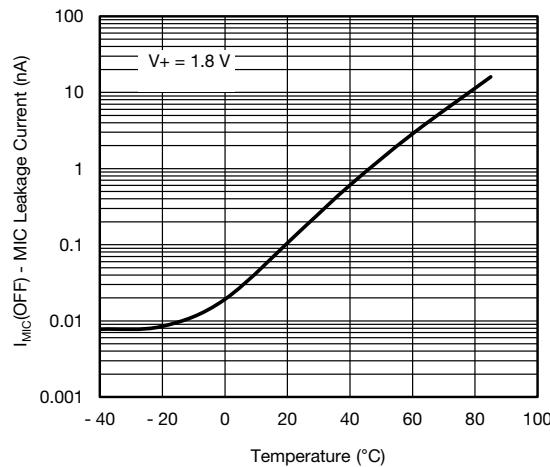
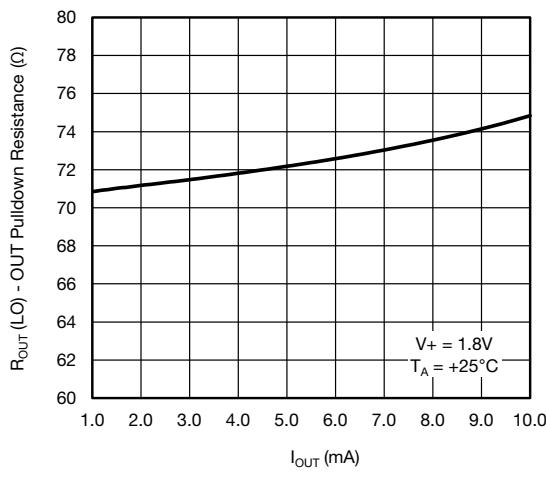
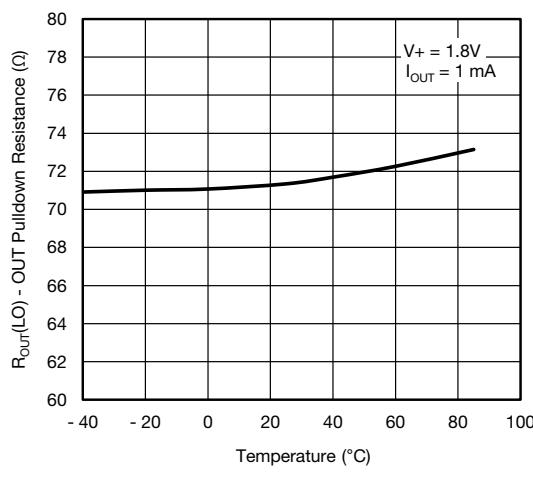
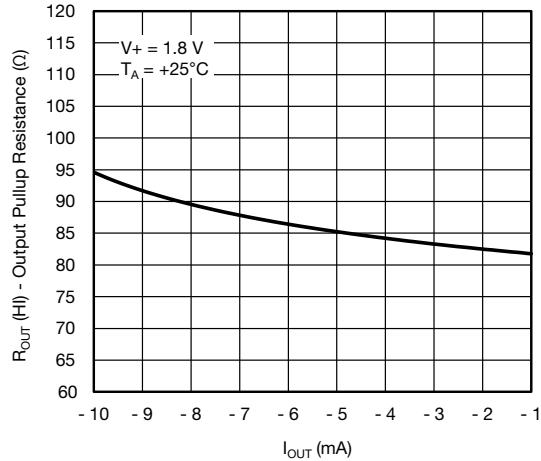
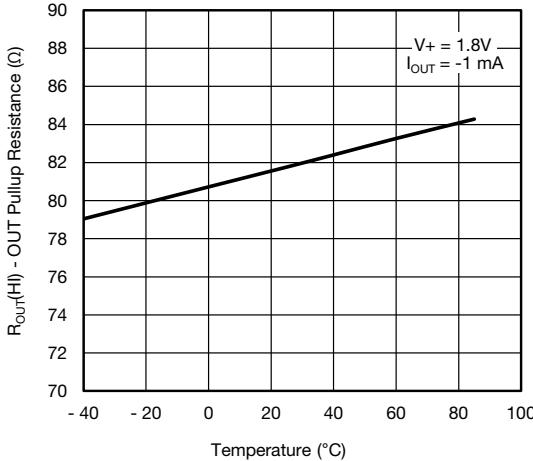
Notes

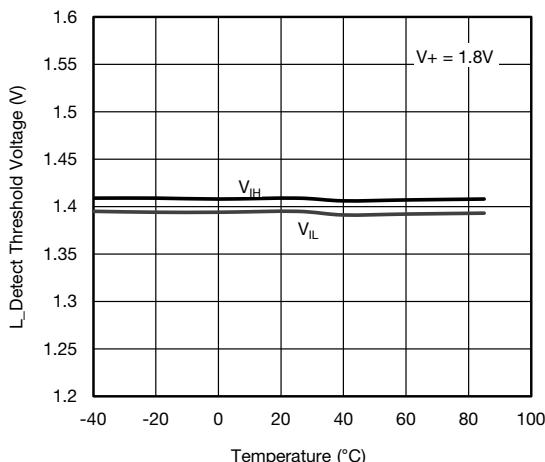
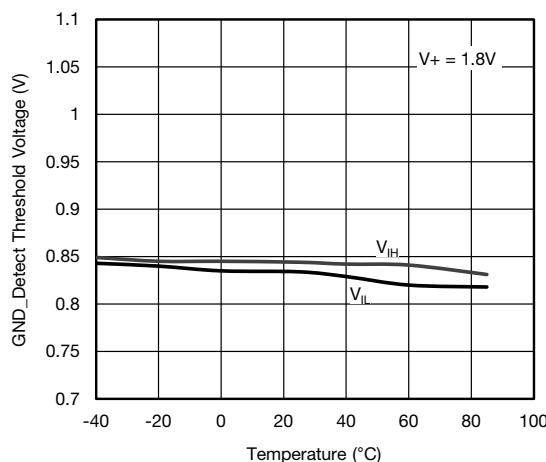
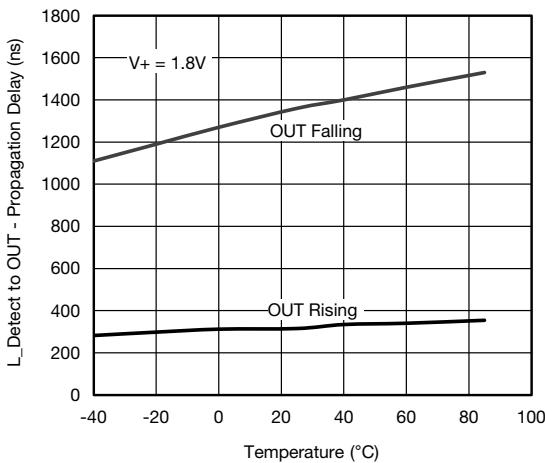
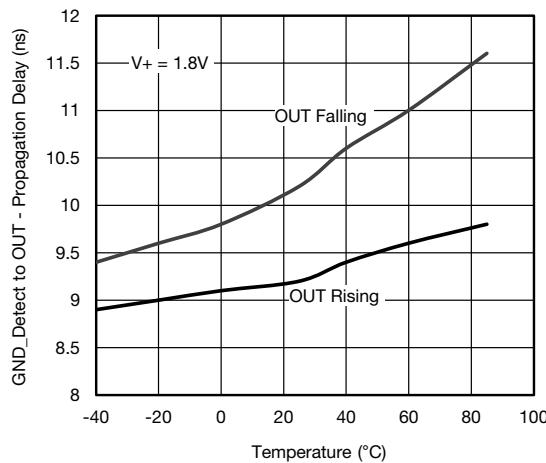
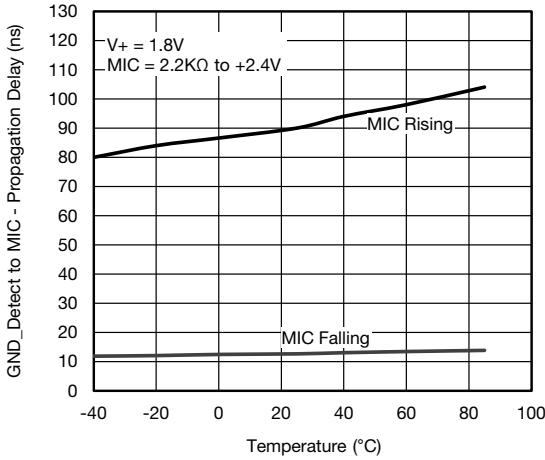
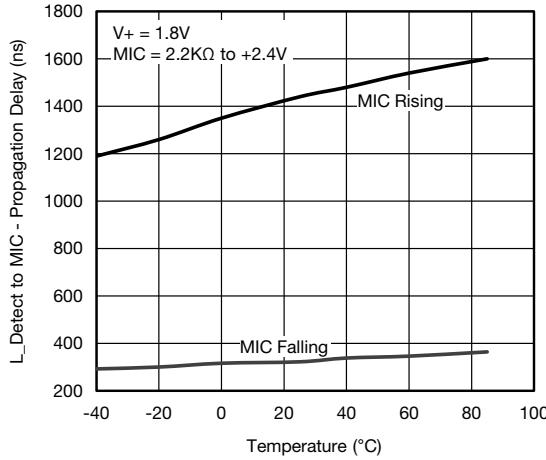
- The control logic pins should not float. It should be compliant with either high or low logic
- Negative current injection up to 300 mA

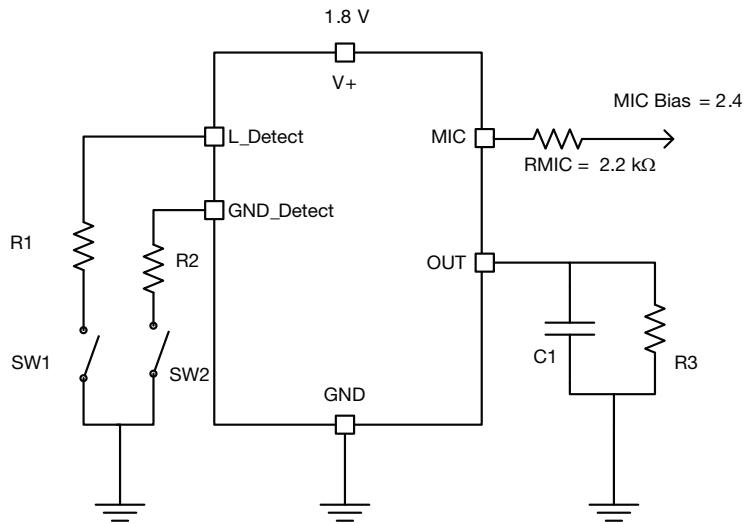
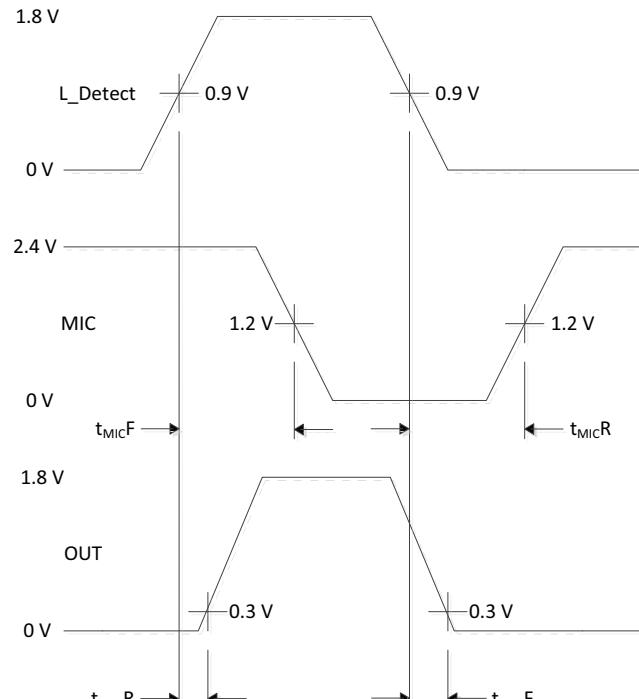
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS						
PARAMETER	SYMBOL	TEST CONDITION	LIMITS			UNIT
		UNLESS OTHERWISE SPECIFIED, $T_A = -40^\circ\text{C}$ to 85°C , TYPICAL VALUES are at 25°C	MIN.	TYP.	MAX.	
Quiescent Current	I_Q	$V_+ = 1.8 \text{ V}$; L_Detect, GND_Detect are open	-	< 1	2	μA
Ear Jack In Current	I_{DETECT}	$V_+ = 1.8 \text{ V}$; L_Detect, GND_Detect are connected with $10 \text{ k}\Omega$ to GND	-	-	5	
L_Detect Reference Voltage			1.33	1.4	1.47	V
L_Detect Reference Voltage Hysteresis		GND_Detect = 0 V	-	20	-	mV
GND_Detect Logic Low Voltage		$V_+ = 1.8 \text{ V}$	0.6	0.84	-	V
GND_Detect Logic High Voltage		$V_+ = 1.8 \text{ V}$	-	-	1.1	
MIC Switch Resistance	R_{MIC}	$V_+ = 1.8 \text{ V}$; $I_{\text{MIC}} = 10 \text{ mA}$ L_Detect, GND_Detect = Open	-	-	1	Ω
MIC Leakage		$V_{\text{MIC}} = 2.4 \text{ V}$	-1	-	1	μA
OUT Pull Up Resistance	R_{OUTH}	$V_+ = 1.8 \text{ V}$; L_Detect, GND_Detect = Open	-	-	110	Ω
OUT Pull Down Resistance	R_{OUTL}	$V_+ = 1.8 \text{ V}$; L_Detect, GND_Detect are connected with $10 \text{ k}\Omega$ to GND,	-	-	100	
OUT High Logic Voltage	V_{OUTH}	$V_+ = 1.8 \text{ V}$; $R_{\text{OUT}} = 10 \text{ k}\Omega$ L_Detect, GND_Detect = Open	1.6	-	-	V
OUT Low Logic Voltage	V_{OUTL}	$V_+ = 1.8 \text{ V}$; $R_{\text{OUT}} = 10 \text{ k}\Omega$ L_Detect, GND_Detect are connected with $10 \text{ k}\Omega$ to GND,	-	-	0.3	
MIC Rising Propagation Delay (insertion detection time)	t_{MICR}	From SW1 and SW2 ON, GND_Detect = 0 V, voltage on L_Detect drops to 0.9 V, to the time when MIC rises to 1.2 V and OUT falls below 0.3 V (refer to circuit below, $R3 = 10\text{K}$, $C1 = 5 \text{ pF}$, MIC biased at 2.4 V via a 2.2K resistor)	-	1.5	2	μs
MIC Falling Propagation Delay (removal detection time)	t_{MIFC}	From SW1 and SW2 ON, GND_Detect = 0 V, voltage on L_Detect rises to 0.9 V, to the time when MIC drops to 1.2 V and OUT rises above 0.3 V (refer to circuit below, $R3 = 10\text{K}$, $C1 = 5 \text{ pF}$, MIC biased at 2.4 V via a 2.2K resistor)	-	350	500	ns
OUT Falling Propagation Delay	t_{OUTF}	From SW1 and SW2 ON, GND_Detect = 0 V, voltage on L_Detect drops to 0.9 V, to the time when MIC rises to 1.2 V and OUT falls below 0.3 V (refer to circuit below, $R3 = 10\text{K}$, $C1 = 5 \text{ pF}$, MIC biased at 2.4 V via a 2.2K resistor)	-	1.4	2	μs
OUT Rising Propagation Delay	t_{OUTR}	From SW1 and SW2 ON, GND_Detect = 0 V, voltage on L_Detect rises to 0.9 V, to the time when MIC drops to 1.2 V and OUT rises above 0.3 V (refer to circuit below, $R3 = 10\text{K}$, $C1 = 5 \text{ pF}$, MIC biased at 2.4 V via a 2.2K resistor)	-	350	500	ns
GND_Detect Capacitance	C_{GD}		-	-	5	pF

TYPICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$, unless otherwise noted)

Quiescent Current vs. V_+

Quiescent Current vs. Temperature

Ear Jack In Current vs. V_+

Ear Jack In Current vs. Temperature

MIC On Resistance vs. V_+

MIC On Resistance vs. Temperature

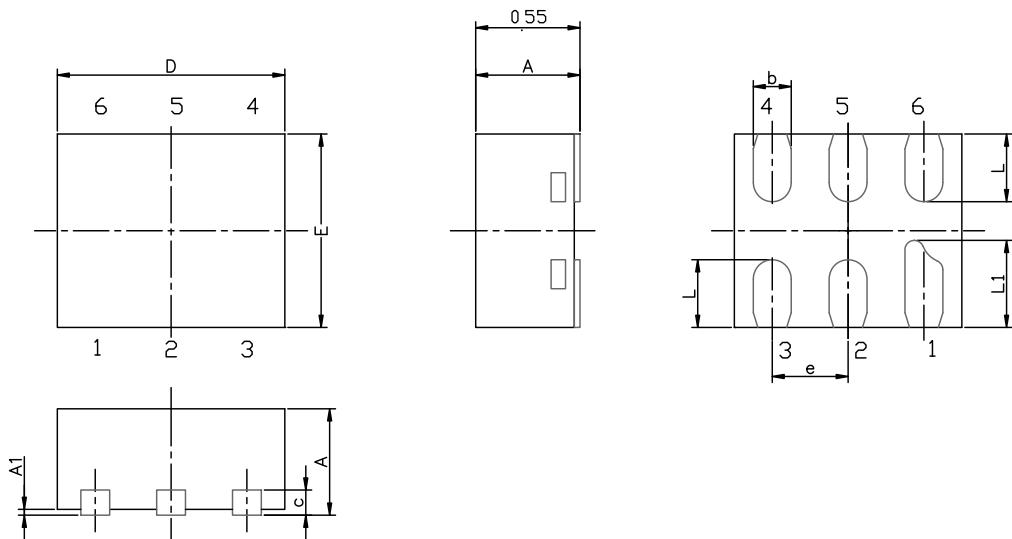
TYPICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$, unless otherwise noted)

MIC Leakage Current vs. V_{MIC}

MIC Leakage Current vs. Temperature

OUT Pulldown Resistance vs. I_{OUT}

OUT Pulldown Resistance vs. Temperature

OUT Pullup Resistance vs. I_{OUT}

OUT Pullup Resistance vs. Temperature

TYPICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$, unless otherwise noted)

L_Detect Threshold Voltage vs. Temperature

GND_Detect Threshold Voltage vs. Temperature

L_Detect to OUT Propagation Delay vs. Temperature

GND_Detect to OUT Propagation Delay vs. Temperature

GND_Detect to MIC Propagation Delay vs. Temperature

L_Detect to MIC Propagation Delay vs. Temperature

TEST CIRCUIT

Fig. 4 - Test Circuit
TIMING DIAGRAM


* GND_Detect = 0 V

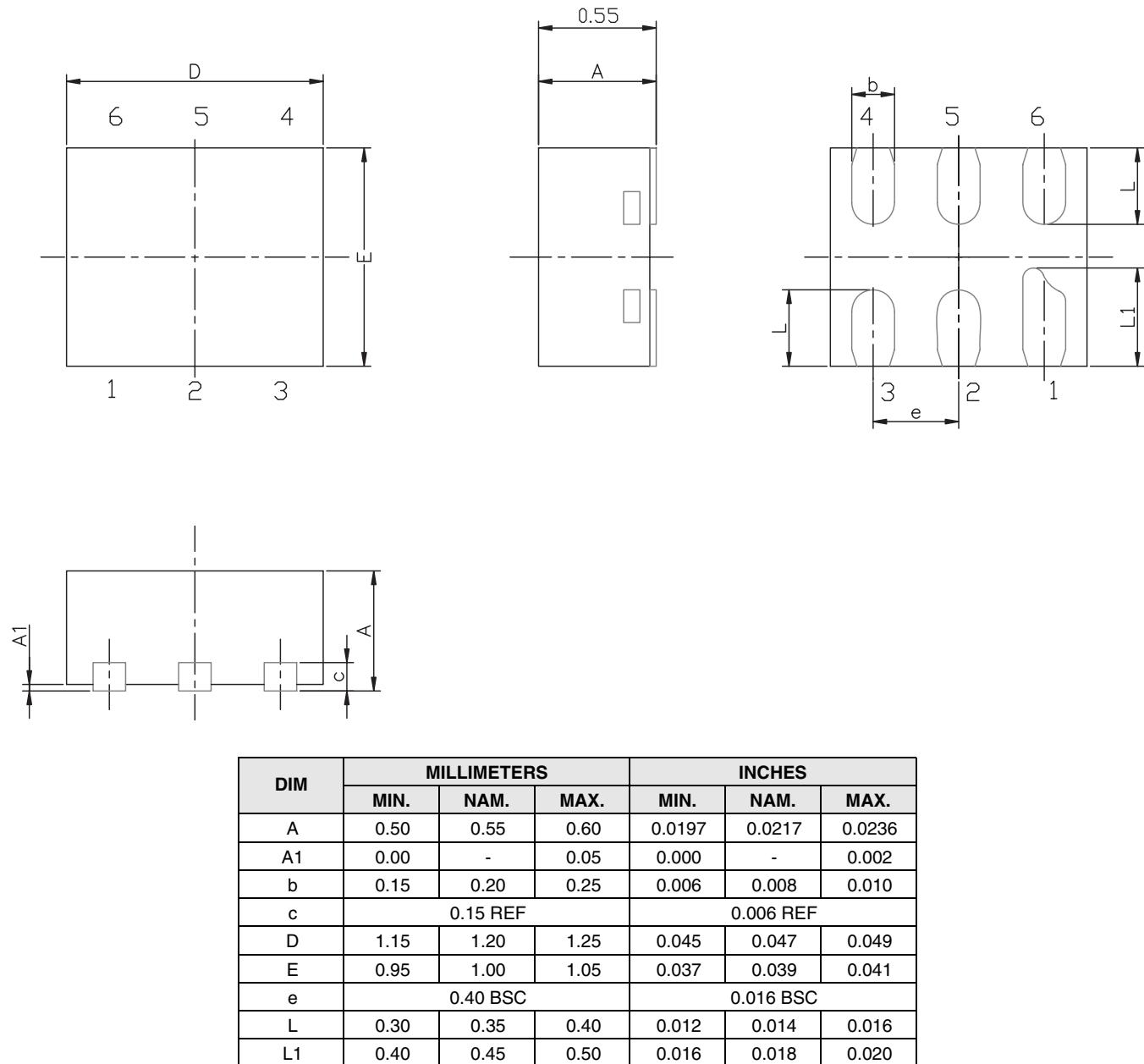
Fig. 5 - Timing Diagram

MINI QFN-6L CASE OUTLINE


DIM.	MILLIMETERS			INCHES		
	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.
A	0.50	0.55	0.60	0.0197	0.0217	0.0236
A1	0	-	0.05	0	-	0.002
b	0.15	0.20	0.25	0.006	0.008	0.010
c	0.15 ref.			0.006 ref.		
D	1.15	1.20	1.25	0.045	0.047	0.049
E	0.95	1.00	1.05	0.037	0.039	0.041
e	0.40 BSC			0.016 BSC		
L	0.30	0.35	0.40	0.012	0.014	0.016
L1	0.40	0.45	0.50	0.016	0.018	0.020

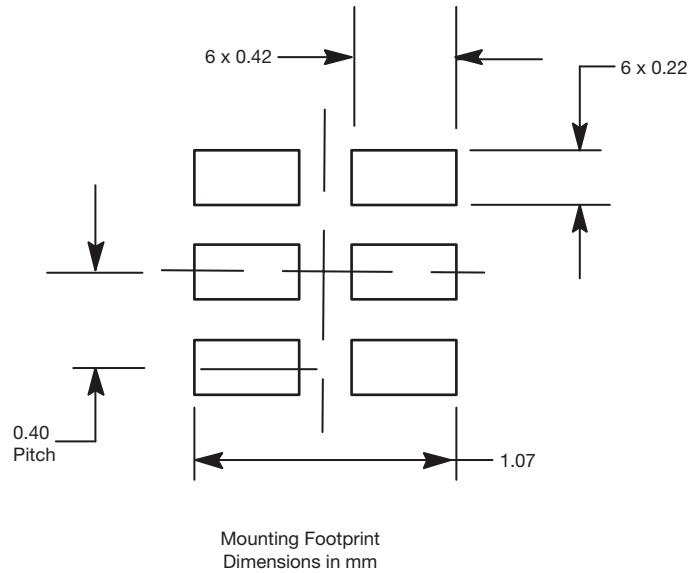
Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?62887.

MINI QFN-6L CASE OUTLINE



ECN T-07039-Rev. A, 12-Feb-07
DWG: 5958

RECOMMENDED MINIMUM PADS FOR MINI QFN 6L





Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and/or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.

Material Category Policy

Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as RoHS-Compliant fulfill the definitions and restrictions defined under Directive 2011/65/EU of The European Parliament and of the Council of June 8, 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment (EEE) - recast, unless otherwise specified as non-compliant.

Please note that some Vishay documentation may still make reference to RoHS Directive 2002/95/EC. We confirm that all the products identified as being compliant to Directive 2002/95/EC conform to Directive 2011/65/EU.

Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as Halogen-Free follow Halogen-Free requirements as per JEDEC JS709A standards. Please note that some Vishay documentation may still make reference to the IEC 61249-2-21 definition. We confirm that all the products identified as being compliant to IEC 61249-2-21 conform to JEDEC JS709A standards.

Данный компонент на территории Российской Федерации**Вы можете приобрести в компании MosChip.**

Для оперативного оформления запроса Вам необходимо перейти по данной ссылке:

<http://moschip.ru/get-element>

Вы можете разместить у нас заказ для любого Вашего проекта, будь то серийное производство или разработка единичного прибора.

В нашем ассортименте представлены ведущие мировые производители активных и пассивных электронных компонентов.

Нашей специализацией является поставка электронной компонентной базы двойного назначения, продукции таких производителей как XILINX, Intel (ex.ALTERA), Vicor, Microchip, Texas Instruments, Analog Devices, Mini-Circuits, Amphenol, Glenair.

Сотрудничество с глобальными дистрибуторами электронных компонентов, предоставляет возможность заказывать и получать с международных складов практически любой перечень компонентов в оптимальные для Вас сроки.

На всех этапах разработки и производства наши партнеры могут получить квалифицированную поддержку опытных инженеров.

Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ Р В 0015-002 и ЭС РД 009

Офис по работе с юридическими лицами:

105318, г.Москва, ул.Щербаковская д.3, офис 1107, 1118, ДЦ «Щербаковский»

Телефон: +7 495 668-12-70 (многоканальный)

Факс: +7 495 668-12-70 (доб.304)

E-mail: info@moschip.ru

Skype отдела продаж:

moschip.ru
moschip.ru_4

moschip.ru_6
moschip.ru_9